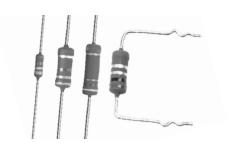


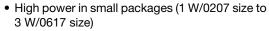
Power Metal Film Leaded Resistors



DESCRIPTION

A homogeneous film of metal alloy is deposited on a high grade ceramic body. After a helical groove has been cut in the resistive layer, tinned connecting wires of electrolytic copper or copper-clad iron are welded to the end-caps. The resistors are coated with a red, non-flammable lacquer which provides electrical, mechanical and climatic protection. This coating is not resistant to aggressive fluxes and cleaning solvents. The encapsulation is resistant to all cleaning solvents in accordance with IEC 60068-2-45.

FEATURES





Different lead materials for different applications

RoHS COMPLIANT

- Defined interruption behaviour
- Technology: Metal film
- AEC-Q200 qualified (PR01 and PR02)
- Lead (Pb)-free solder contacts
- Pure tin plating provides compatibility with lead (Pb)-free and lead containing soldering processes
- Material categorization: For definitions of compliance please see www.vishav.com/doc?99912

APPLICATIONS

• All general purpose power applications

TECHNICAL SPECIFICATION	IS						
DESCRIPTION	UNIT	PR01	PR02 Cu-lead	PR02 FeCu-lead	PR03 Cu-lead	PR03 FeCu-lead	
Resistance range (2)	Ω	0.22 to 1M	0.33 to 1M	1 to 1M	0.68 to 1M	1 to 1M	
Resistance tolerance	%	± 1; ± 5	± 1; ± 5	± 1; ± 5	± 1; ± 5	± 1; ± 5	
Resistance series		± 1 (E24, E96); ± 5 (E24 series) (1)					
Rated dissipation, P_{70} 1 $\Omega \le R$	w	1	2	1.3	3	2.5	
$R < 1 \Omega$		0.6	1.2	-	1.6	-	
Thermal resistance (R _{th})	K/W	135	75	115	60	75	
Temperature coefficient	ppm/K	≤ ± 250	≤ ± 250	≤ ± 250	≤ ± 250	≤ ± 250	
Maximum permissible voltage (<i>U</i> _{max.} AC/DC)	V	350	500	500	750	750	
Basic specifications				IEC 60115-1			
Climatic category (IEC 60068-1)				55/155/56			
Stability after:							
Load (1000 h, P ₇₀)		ΔR max.: \pm (5 % R + 0.1 Ω)					
Long term damp heat test (56 days)		ΔR max.: \pm (3 % R + 0.1 Ω)					
Soldering (10 s, 260 °C)			∆R m	ax.: ± (1 % R + 0	.05 Ω)		

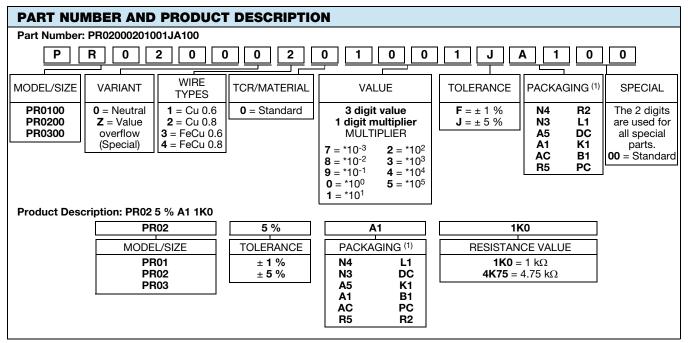
Notes

- R value is measured with probe distance of 24 mm ± 1 mm using 4-terminal method.
- (1) 1 % tolerance is available for R_n -range from 1 R upwards.
- (2) Ohmic values (other than resistance range) are available on request.



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Notes

- The PART NUMBER is shown to facilitate the introduction of a unified part numbering system for ordering products.
- (1) Please refer to table PACKAGING for details.

PACKAGING									
MODEL	TAPING	АММО	PACK	RE	EL	BULK, DOUBLE KINK			
WODEL	TAPING	PIECES	CODE	PIECES	CODE	PITCH	PIECES	CODE	
	Axial, 52 mm	5000	A5	5000	R5				
	Wire Cu 0.6 mm and FeCu 0.6 mm	1000	A1						
PR01	Radial	4000	N4			17.8 mm Wire Cu 0.6 mm or FeCu 0.6 mm	1000	L1	
	Wire Cu 0.6 mm					12.5 mm Wire FeCu 0.6 mm	1000	K1	
	Axial, 52 mm Wire Cu 0.8 mm and FeCu 0.6 mm	1000	A1	5000 only with Cu 0.8 mm	R5				
PR02	Radial Wire Cu 0.8 mm and FeCu 0.6 mm	3000 only with Cu 0.8 mm	N3	2000 only with Cu 0.8 mm	R2	17.8 mm Wire Cu 0.8 mm and FeCu 0.6 mm	1000	L1	
						15.0 mm only with FeCu 0.8 mm Wire FeCu 0.6 mm	1000	B1	
PR03	Axial, 63 mm Wire Cu 0.8 mm and FeCu 0.6 mm	500	AC						
	Radial Wire Cu 0.8 mm					25.4 mm Wire Cu 0.8 mm and FeCu 0.6 mm	500	DC	
	and FeCu 0.6 mm					20 mm Wire FeCu 0.8 mm	500	PC	



DIMENSIONS

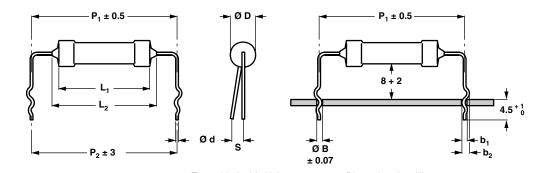
PR03

Double kink

12.5 mm pitch

Type with straight leads

DIMENSIONS - Straight lead type and relevant physical dimensions; see straight leads outline								
TYPE	Ø D _{MAX} .	L _{1 MAX} .	L _{2 MAX} .	Ø d (mm)				
	(mm)	(mm)	(mm)	Cu	FeCu			
PR01	2.5	6.5	8.0	0.58 ± 0.05	-			
PR02	3.9	10.0	12.0	0.78 ± 0.05	0.58 ± 0.05			
PR03	5.2	16.7	19.5	0.78 ± 0.05	0.58 ± 0.05			



DIMENSIONS - Double kink lead type and relevant physical dimensions; see double kinked outline Ød ØВ b_1 b_2 Ø D_{MAX} (mm) SMAX. **TYPE LEAD STYLE** (mm) (mm) (mm) (mm) (mm) (mm) (mm) Cu **FeCu** 1.10 Double kink 1.45 0.58 ± 0.05 0.58 ± 0.05 17.8 17.8 2 8.0 17.8 mm pitch + 0.25/- 0.20 + 0.25/- 0.20 PR01 2.5 Double kink 1.10 1.45 0.58 ± 0.05 12.5 2 0.8 12.5 mm pitch + 0.25/- 0.20 + 0.25/- 0.20 Double kink 1.10 1.45 0.78 ± 0.05 0.58 ± 0.05 17.8 17.8 2 8.0 + 0.25/- 0.20 + 0.25/- 0.20 17.8 mm pitch PR02 3.9 Double kink 1.30 1.65 0.78 ± 0.05 15.0 15.0 2 1.0 12.5 mm pitch + 0.25/- 0.20 + 0.25/- 0.20 Double kink 1.10 1.65 0.78 ± 0.05 0.58 ± 0.05 25.4 25.4 2 1.0 17.8 mm pitch + 0.25/- 0.20 + 0.25/- 0.20

1.30

+ 0.25/- 0.20

 0.78 ± 0.05

5.2

22.0

20.0

2

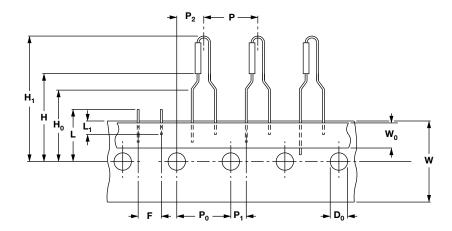
1.0

2.15

+ 0.25/- 0.20



PRODUCTS WITH RADIAL LEADS (PR01, PR02)



DIMENSIONS - Radial taping								
SYMBOL	PARAMETER	VALUE	TOLERANCE	UNIT				
Р	Pitch of components	12.7	± 1.0	mm				
P ₀	Feed-hole pitch	12.7	± 0.2	mm				
P ₁	Feed-hole centre to lead at topside at the tape	3.85	± 0.5	mm				
P ₂	Feed-hole center to body center	6.35	± 1.0	mm				
F	Lead-to-lead distance	4.8	+ 0.7/- 0	mm				
W	Tape width	18.0	± 0.5	mm				
W ₀	Minimum hold down tape width	5.5	-	mm				
H1	Component height PR01	29	Max.					
П	Component height PR02	29	± 3.0	mm				
H ₀	Lead wire clinch height	16.5	± 0.5	mm				
Н	Height of component from tape center	19.5	± 1	mm				
D ₀	Feed-hole diameter	4.0	± 0.2	mm				
L	Maximum length of snipped lead	11.0	-	mm				
L ₁	Minimum lead wire (tape portion) shortest lead	2.5	-	mm				

Note

• Please refer Packaging document (<u>www.vishay.com/doc?28721</u>) for more detail.



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MASS PER UNIT					
TYPE	MASS (mg)				
PR01 Cu 0.6 mm	212				
PR01 FeCu 0.6 mm	207				
PR02 Cu 0.8 mm	504				
PR02 FeCu 0.6 mm	455				
PR02 FeCu 0.8 mm	496				
PR03 Cu 0.8 mm	1192				
PR03 FeCu 0.6 mm	1079				
PR03 FeCu 0.8 mm	1185				

MARKING

The nominal resistance and tolerance are marked on the resistor using four or five colored bands in accordance with IEC 60062, marking codes for resistors and capacitors.

OUTLINES

The length of the body (L_1) is measured by inserting the leads into holes of two identical gauge plates and moving these plates parallel to each other until the resistor body is clamped without deformation (IEC 60294).

MOUNTING

The resistors are suitable for processing on automatic insertion equipment and cutting and bending machines.

MOUNTING PITCH						
TYPE	LEAD STYLE	PIT	СН			
ITPE	LEAD STILE	mm	е			
	Straight leads	12.5 ⁽¹⁾	5 (1)			
PR01	Radial taped	4.8	2			
Phui	Double kink large pitch	17.8	7			
	Double kink small pitch	12.5	5			
	Straight leads	15.0 ⁽¹⁾	6 ⁽¹⁾			
PR02	Radial taped	4.8	2			
Phu2	Double kink large pitch	17.8	7			
	Double kink small pitch	15.0	6			
	Straight leads	23.0 (1)	9 (1)			
PR03	Double kink large pitch	25.4	10			
	Double kink small pitch	20.0	8			

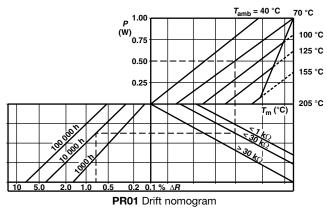
Note

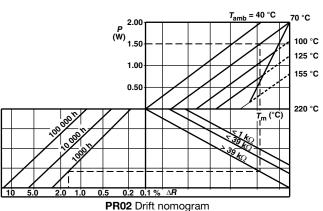
(1) Recommended minimum value.

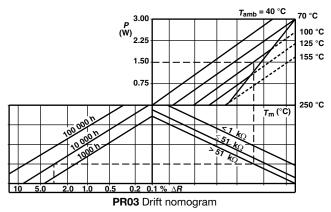
FUNCTIONAL DESCRIPTION PRODUCT CHARACTERIZATION

Standard values of nominal resistance are taken from the E96/E24 series for resistors with a tolerance of \pm 1 % or \pm 5 %. The values of the E96/E24 series are in accordance with IEC 60063.

FUNCTIONAL PERFORMANCE





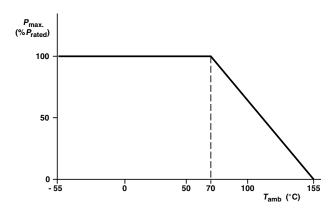


Note

 The maximum permissible hot-spot temperature is 205 °C for PR01, 220 °C for PR02 and 250 °C for PR03.

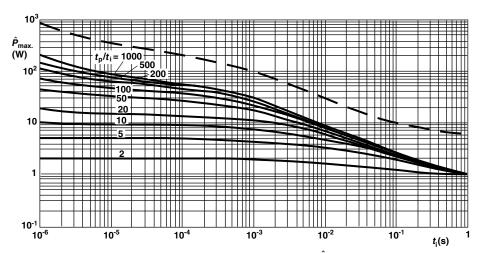
DERATING

The power that the resistor can dissipate depends on the operating temperature.

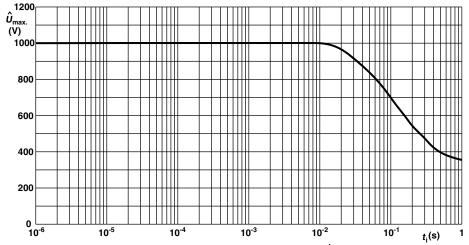


Maximum dissipation (P_{max}) in percentage of rated power as a function of the ambient temperature (T_{amb})

PULSE LOADING CAPABILITIES

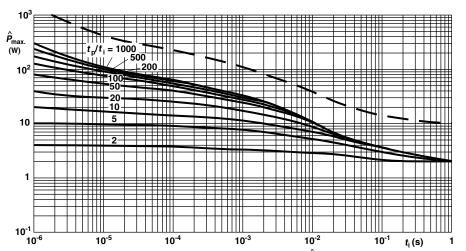


PR01 Pulse on a regular basis; maximum permissible peak pulse power (\hat{P}_{max}) as a function of pulse duration (t_i)

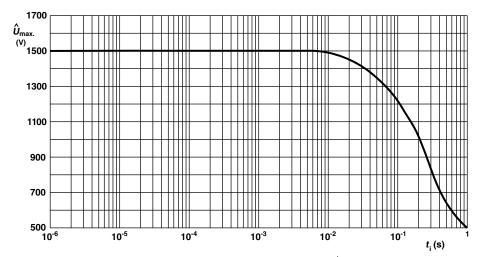


PR01 Pulse on a regular basis; maximum permissible peak pulse voltage (\hat{U}_{max}) as a function of pulse duration (t_i)

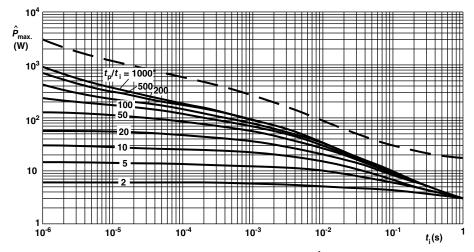
PULSE LOADING CAPABILITIES



PR02 Pulse on a regular basis; maximum permissible peak pulse power (\hat{P}_{max}) as a function of pulse duration (t_i)

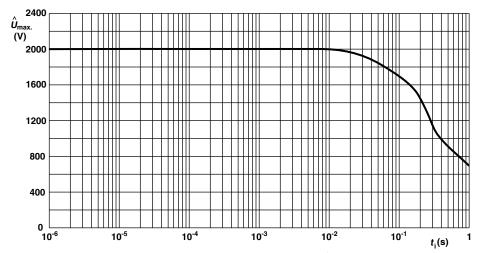


PR02 Pulse on a regular basis; maximum permissible peak pulse voltage (\hat{U}_{max}) as a function of pulse duration (t_i)



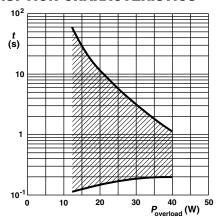
PR03 Pulse on a regular basis; maximum permissible peak pulse power (\hat{P}_{max}) as a function of pulse duration (t_i)

PULSE LOADING CAPABILITIES



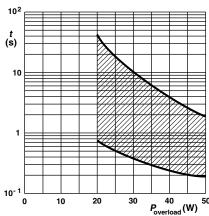
PR03 Pulse on a regular basis; maximum permissible peak pulse voltage (\hat{U}_{max}) as a function of pulse duration (t_i)

INTERRUPTION CHARACTERISTICS



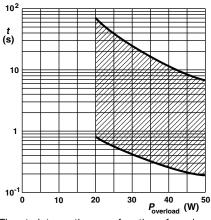
PR01 Time to interruption as a function of overload power for range: $0 R 22 \le R_v < 1 R$

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



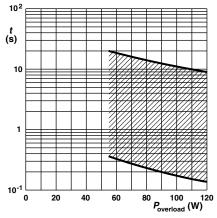
PR01 Time to interruption as a function of overload power for range: $1 R \le R_n \le 15 R$

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



PR01 Time to interruption as a function of overload power for range: $16 R \le R_n \le 560 R$

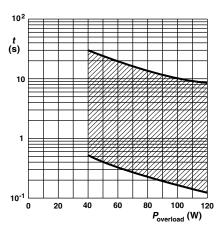
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



PR02 Time to interruption as a function of overload power for range: $0.33 R \le R_n \le 5 R$

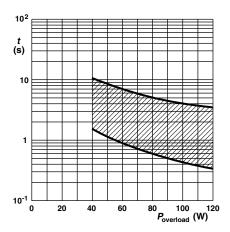
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.

INTERRUPTION CHARACTERISTICS



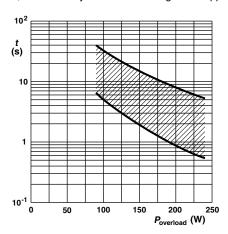
PR02 Time to interruption as a function of overload power for range: $5 R \le R_n \le 68 R$

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



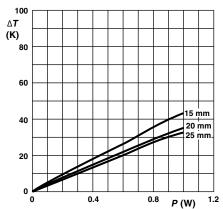
PR02 Time to interruption as a function of overload power for range: $68 R \le R_n \le 560 R$

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



PR03 Time to interruption as a function of overload power for range: $0.68\ R \le R_n \le 560\ R$ This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.

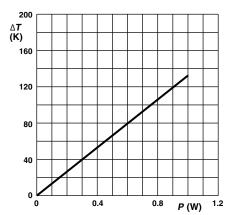
APPLICATION INFORMATION



Ø 0.6 mm Cu-leads

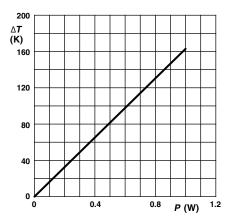
Minimum distance from resistor body to PCB = 1 mm

PR01 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø 0.6 mm Cu-leads

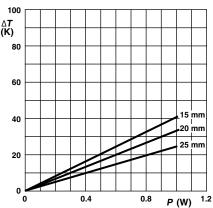
PR01 Hot-spot temperature rise (ΔT) as a function of dissipated power.



Ø 0.6 mm FeCu-leads

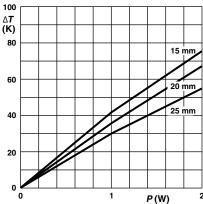
PR01 Hot-spot temperature rise (ΔT) as a function of dissipated power.

APPLICATION INFORMATION



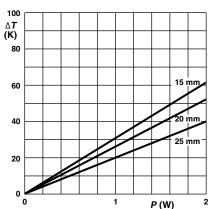
Ø 0.6 mm FeCu-leads Minimum distance from resistor body to PCB = 1 mm

PR01 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø 0.8 mm Cu-leads Minimum distance from resistor body to PCB = 1 mm

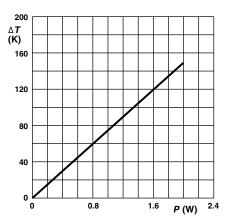
PR02 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø 0.6 mm FeCu-leads

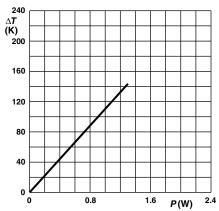
Minimum distance from resistor body to PCB = 1 mm

PR02 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



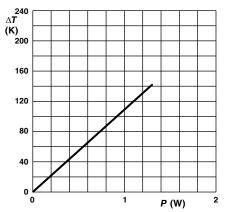
Ø 0.8 mm Cu-leads

PR02 Hot-spot temperature rise (ΔT) as a function of dissipated power.



Ø 0.6 mm FeCu-leads

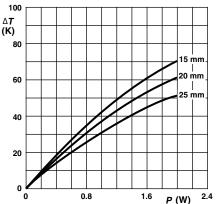
PR02 Hot-spot temperature rise (ΔT) as a function of dissipated power.



Ø 0.8 mm FeCu-leads

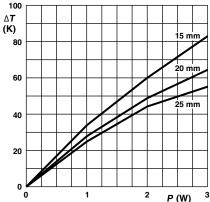
PR02 Hot-spot temperature rise (ΔT) as a function of dissipated power.

APPLICATION INFORMATION



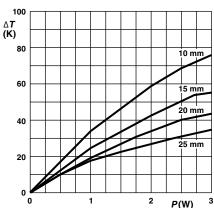
Ø 0.8 mm FeCu-leads Minimum distance from resistor body to PCB = 1 mm

PR02 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



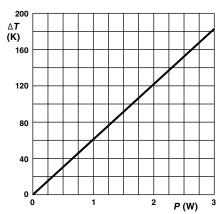
Ø 0.8 mm Cu-leads
Minimum distance from resistor body to PCB = 1 mm

PR03 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



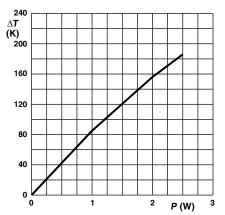
Ø 0.6 mm FeCu-leads Minimum distance from resistor body to PCB = 1 mm

PR03 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



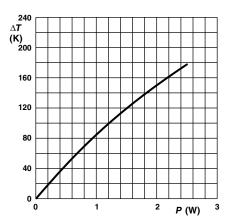
Ø 0.8 mm Cu-leads

PR03 Hot-spot temperature rise (ΔT) as a function of dissipated power.



Ø 0.6 mm FeCu-leads

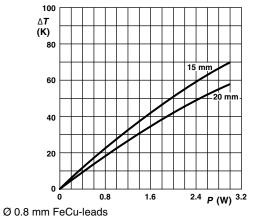
PR03 Hot-spot temperature rise (ΔT) as a function of dissipated power.



Ø 0.8 mm FeCu-leads

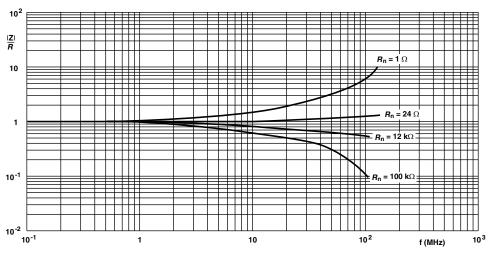
PR03 Hot-spot temperature rise (ΔT) as a function of dissipated power.

APPLICATION INFORMATION

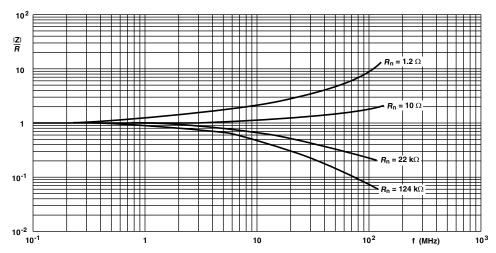


Minimum distance from resistor body to PCB = 1 mm

PR03 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



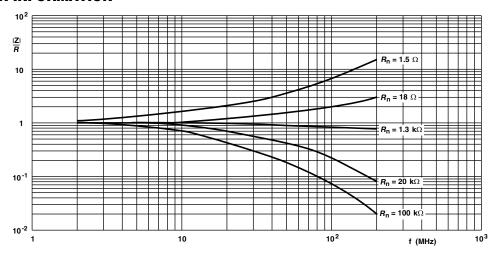
PR01 Impedance as a function of applied frequency



PR02 Impedance as a function of applied frequency



APPLICATION INFORMATION



PR03 Impedance as a function of applied frequency

TESTS AND REQUIREMENTS

Essentially all tests are carried out in accordance with IEC 60115-1 specification, category LCT/UCT/56 (rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days).

The tests are carried out in accordance with IEC 60068-2-xx Test Method under standard atmospheric conditions according to IEC 60068-1, 5.3.

In the Test Procedures and Requirements table, tests and requirements are listed with reference to the relevant clauses of IEC 60115-1 and IEC 60068-2-xx test methods. A short description of the test procedure is also given. In some instances deviations from the IEC recommendations were necessary for our method of specifying.

All soldering tests are performed with mildly activated flux.

TEST P	TEST PROCEDURES AND REQUIREMENTS							
IEC 60115-1 CLAUSE	IEC 60068-2- TEST METHOD	TEST	PROCEDURE	REQUIREMENTS				
4.4.1		Visual examination		No holes; clean surface; no damage				
4.4.2		Dimensions (outline)	Gauge (mm)	See Straight and Kinked Dimensions tables				
			Applied voltage (+ 0 %/- 10 %):					
			R< 10 Ω: 0.1 V					
		Resistance (refer note on first page for measuring distance)	10 Ω ≤ <i>R</i> < 100 Ω: 0.3 V					
4.5			100 Ω ≤ <i>R</i> < 1 kΩ: 1 V	$R - R_{\text{nom}}$ max. ± 5 %				
4.5			1 kΩ ≤ <i>R</i> < 10 kΩ: 3 V	71 - 71 _{nom:} 111ax. ± 3 /0				
			10 kΩ ≤ <i>R</i> < 100 kΩ: 10 V					
			100 kΩ ≤ <i>R</i> < 1 MΩ: 25 V					
			R = 1 MΩ: 50 V					
4.18	20 (Tb)	Resistance to soldering heat	Thermal shock: 10 s; 260 °C; 3 mm from body	ΔR_{max} : ± (1 % R + 0.05 Ω)				
4.29	45 (Xa)	Component solvent resistance	Isopropyl alcohol or H ₂ O followed by brushing	No visual damage				
4.17	20 (Ta)	Solderability	2 s; 235 °C; Solder bath method; SnPb40 3 s; 245 °C; Solder bath method; SnAg3Cu0.5	Good tinning (≥ 95 % covered); no damage				
		Solderability (after ageing)	8 h steam or 16 h 155 °C; leads immersed 6 mm: for 2 s at 235 °C; solder bath (SnPb40) for 3 s at 245 °C; solder bath (SnAg3Cu0.5)	Good tinning (≥ 95 % covered); no damage				



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IEC 60115-1 CLAUSE	IEC 60068-2- TEST METHOD	TEST	PROCEDURE	REQUIREMENTS
4.7		Voltage proof on insulation	Maximum voltage $U_{\rm RMS}$ = 500 V during 1 min; metal block method	No breakdown or flashover
4.16		Robustness of terminations:		
4.16.2	21 (Ua1)	Tensile all samples	Load 10 N; 10 s	Number of failures: < 1 x 10 ⁻⁶
4.16.3	21 (Ub)	Bending half number of samples	Load 5 N; 4 x 90°	Number of failures: < 1 x 10 ⁻⁶
4.16.4	21 (Uc)	Torsion other half of samples	3 x 360° in opposite directions	No damage ΔR_{max} : ± (0.5 % R + 0.05 Ω)
4.20	29 (Eb)	Bump	3 x 1500 bumps in three directions; 40 g	No damage ΔR_{max} : ± (0.5 % R + 0.05 Ω)
4.22	6 (Fc)	Vibration	Frequency 10 Hz to 500 Hz; displacement 1.5 mm or acceleration 10 g; three directions; total 6 h (3 x 2 h)	No damage $\Delta R_{\text{max.}}$: ± (0.5 % R + 0.05 Ω)
4.19	14 (Na)	Rapid change of temperature	30 min at LCT and 30 min at UCT; 5 cycles	No visual damage PR01 : ΔR_{max} : \pm (1 % R + 0.05 Ω PR02 : ΔR_{max} : \pm (1 % R + 0.05 Ω PR03 : ΔR_{max} : \pm (2 % R + 0.05 Ω
4.23		Climatic sequence:		
4.23.2	2 (Ba)	Dry heat	16 h; 155 °C	
4.23.3	30 (Db)	Damp heat (accelerated) 1 st cycle	24 h; 55 °C; 90 % to 100 % RH	
4.23.4	1 (Aa)	Cold	2 h; - 55 °C	
4.23.5	13 (M)	Low air pressure	2 h; 8.5 kPa; 15 °C to 35 °C	
4.23.6	30 (Db)	Damp heat (accelerated) remaining cycles	5 days; 55 °C; 95 % to 100 % RH	$R_{\text{ins min.}}$: 10 ³ M Ω $\Delta R_{\text{max.}}$: ± (1.5 % R + 0.1 Ω)
4.24	78 (Cab)	Damp heat (steady state)	56 days; 40 °C; 90 % to 95 % RH; loaded with 0.01 <i>P</i> ₇₀ (Steps: 0 V to 100 V)	$R_{\text{ins min}}$: 1000 MΩ ΔR_{max} : ± (3 % R + 0.1 Ω)
4.25.1		Endurance (at 70 °C)	1000 h; loaded with P_{70} or $U_{\rm max}$; 1.5 h ON and 0.5 h OFF	ΔR_{max} : ± (5 % R + 0.1 Ω)
4.8		Temperature coefficient	Between - 55 °C and + 155 °C	≤ ± 250 ppm/K
4.6.1.1		Insulation resistance	Maximum voltage (DC) after 1 min; metal block method	$R_{\rm ins\ min}$: $10^4\ { m M}\Omega$



12NC INFORMATION FOR HISTORICAL CODING REFERENCE

The resistors have a 12-digit numeric code starting with 23 For 5 % tolerance:

- The next 7 digits indicate the resistor type and packing
- The remaining 3 digits indicate the resistance value:
 - The first 2 digits indicate the resistance value
 - The last digit indicates the resistance decade

For 1 % tolerance:

- The next 6 digits indicate the resistor type and packing
- The remaining 4 digits indicate the resistance value:
 - The first 3 digits indicate the resistance value
 - The last digit indicates the resistance decade

Last Digit of 12NC Indicating Resistance Decade

RESISTANCE DECADE	LAST DIGIT
0.22 Ω to 0.91 Ω	7
1 Ω to 9.76 Ω	8
10 Ω to 97.6 Ω	9
100 Ω to 976 Ω	1
1 Ω to 9.76 k Ω	2
10 Ω to 97.6 k Ω	3
100 Ω to 976 k Ω	4
1 ΜΩ	5

12NC Example

The 12NC for resistor type PR02 with Cu leads and a value of 750 Ω with 5 % tolerance, supplied on a bandolier of 1000 units in ammopack, is: 2306 198 53751.

12NC	12NC - Resistor Type and Packaging (1)											
					23	3 (BAND	OLIER)					
	LEAD G	TOI			AMMOPACK				REEL			
TYPE	LEAD Ø mm	TOL. (%)	DADIAL	TAPED		STRAIGH	IT LEADS		RADIAL TAPED			
		(/0)	HADIAL	IAPED	52 mm	52 mm	63 mm	52 mm	RADIAL TAPED			
			4000 UNITS	3000 UNITS	5000 UNITS	1000 UNITS	500 UNITS	5000 UNITS	2000 UNITS			
PR01	Cu 0.6	1	-	-	22 196 1	06 191 2	-	06 191 5	-			
Phui	Cu 0.6	5	06 197 03	-	22 193 14	06 197 53	-	06 197 23	-			
	Cu 0.8	1	-	22 197 2	-	22 197 1	-	06 192 5	2322 197 5			
PR02	Cu 0.6		Cu 0.8	Cu 0.8	5	-	06 198 03	-	06 198 53	-	06 198 23	2322 198 04
	FeCu 0.6	5	-	-	-	22 194 54	-	-	-			
	Cu 0.8	5	-	-	-	-	22 195 14	-	-			
PR03	Cu 0.8	1	-	-	-	-	06 199 6	-	-			
	FeCu 0.6	5	-	-	-	-	22 195 54	-	ī			

Notes

⁽¹⁾ Other packaging versions are available on request.

12NC	12NC - Resistor Type and Packaging								
				23 (LOOSE IN BOX)					
TYPE	LEAD Ø	TOL.		DOUBLE	KINK				
ITPE	mm	(%)	PITCH = 17.8 mm	PITCH = 25.4 mm	PITCH (2)(3)(4)			
			1000 UNITS	500 UNITS	1000 UNITS	500 UNITS			
DD01	Cu 0.6	5	22 193 03	-	-	-			
PR01	FeCu 0.6	5	22 193 43	-	22 193 53 ⁽²⁾	-			
	Cu 0.8	5	22 194 23	-	-	-			
PR02	FeCu 0.6	5	22 194 83	-	-	-			
	FeCu 0.8	5	-	-	22 194 63 ⁽³⁾	-			
	Cu 0.8	5	-	22 195 23	-	-			
PR03	FeCu 0.6	5	-	22 195 83	-	-			
	FeCu 0.8	5	=	=	-	22 195 63 ⁽⁴⁾			

Notes

- Preferred types in bold.
- (2) PR01 pitch 12.5 mm.
- (3) PR02 pitch 15.0 mm.
- (4) PR03 pitch 20.0 mm, with reversed kinking direction as opposed to the drawing for the type with double kink figure.

[·] Preferred types in bold.



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Revision: 02-Oct-12 Document Number: 91000